

WNM4153

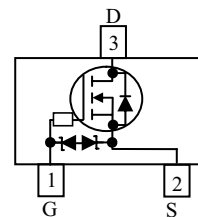
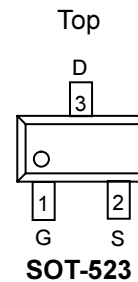
N-Channel, 20V, 0.88A, Small Signal MOSFET

[Http://www.willsemi.com](http://www.willsemi.com)

V_{DS} (V)	$R_{DS(on)}$ (Ω)
20	0.220 @ $V_{GS}=4.5V$
	0.260 @ $V_{GS}=2.5V$
	0.320 @ $V_{GS}=1.8V$

Descriptions

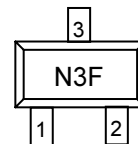
The WNM4153 is the N-Channel enhancement MOS Field Effect Transistor, uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in DC-DC conversion applications. Standard Product WNM4153 is Pb-free.



Pin Configuration

Features

- Trench N-Channel
- Supper high density cell design for extremely low $R_{ds(on)}$
- Exceptional ON resistance and maximum DC current capability
- Small package design with SOT-523



N3 = Device Code

F = Month

Marking

Applications

- Driver: Relays, Solenoids, Lamps, Hammers
- Power supply converters circuit
- Load/Power Switching for potable device

Order Information

Device	Package	Shipping
WNM4153-3/TR	SOT-523	3000/Tape&Reel

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	10 S	Steady State	Unit
Drain-Source Voltage		V_{DS}	+20		V
Gate-Source Voltage		V_{GS}	± 6		
Continuous Drain Current ^a	$T_A=25^\circ\text{C}$	I_D	0.88	0.80	A
	$T_A=70^\circ\text{C}$		0.71	0.64	
Maximum Power Dissipation ^a	$T_A=25^\circ\text{C}$	P_D	0.37	0.30	W
	$T_A=70^\circ\text{C}$		0.23	0.19	
Continuous Drain Current ^b	$T_A=25^\circ\text{C}$	I_D	0.76	0.69	A
	$T_A=70^\circ\text{C}$		0.60	0.55	
Maximum Power Dissipation ^b	$T_A=25^\circ\text{C}$	P_D	0.27	0.22	W
	$T_A=70^\circ\text{C}$		0.17	0.14	
Pulsed Drain Current ^c		I_{DM}	1.4		A
Operating Junction Temperature		T_J	150		$^\circ\text{C}$
Lead Temperature		T_L	260		$^\circ\text{C}$
Storage Temperature Range		T_{stg}	-55 to 150		$^\circ\text{C}$

Thermal Resistance Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	$t \leq 10 \text{ s}$	$R_{\theta JA}$	285	335	$^\circ\text{C/W}$
	Steady State		340	405	
Junction-to-Ambient Thermal Resistance ^b	$t \leq 10 \text{ s}$	$R_{\theta JA}$	385	450	
	Steady State		455	545	
Junction-to-Case Thermal Resistance		$R_{\theta JC}$	260	300	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

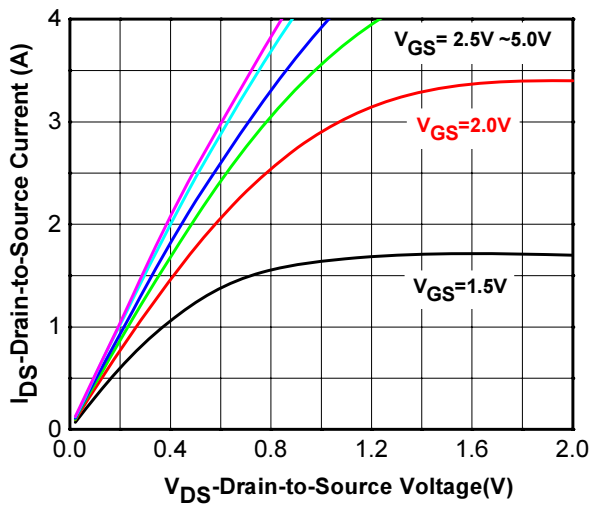
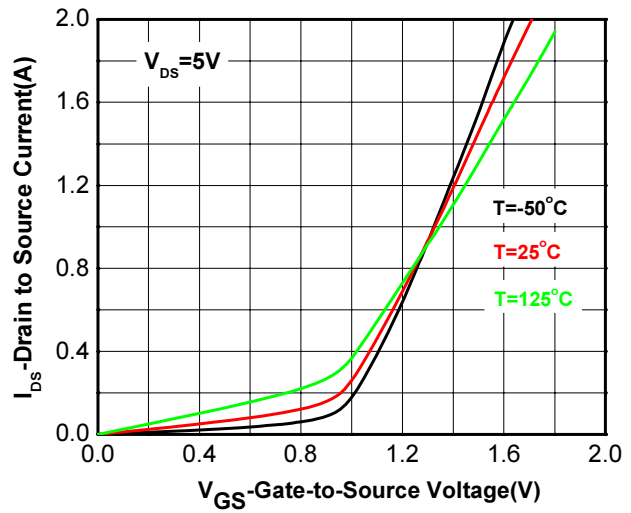
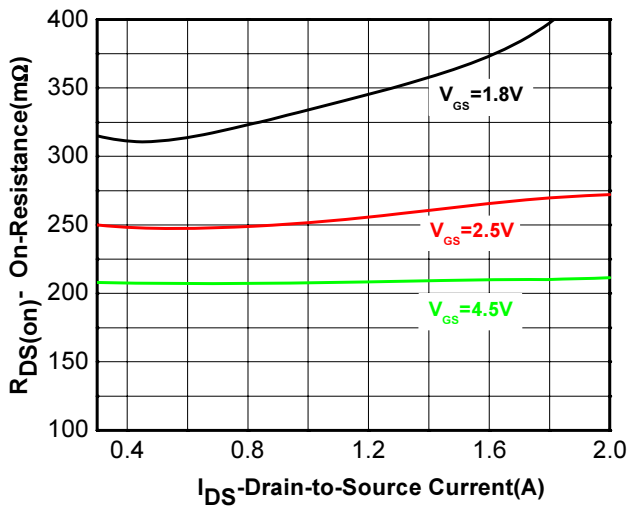
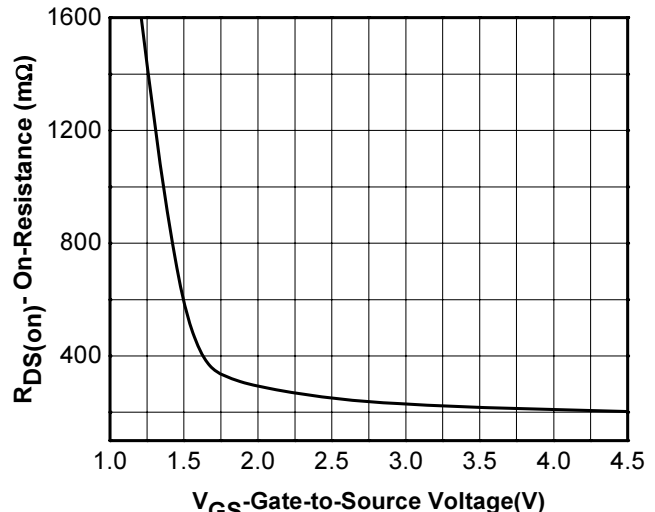
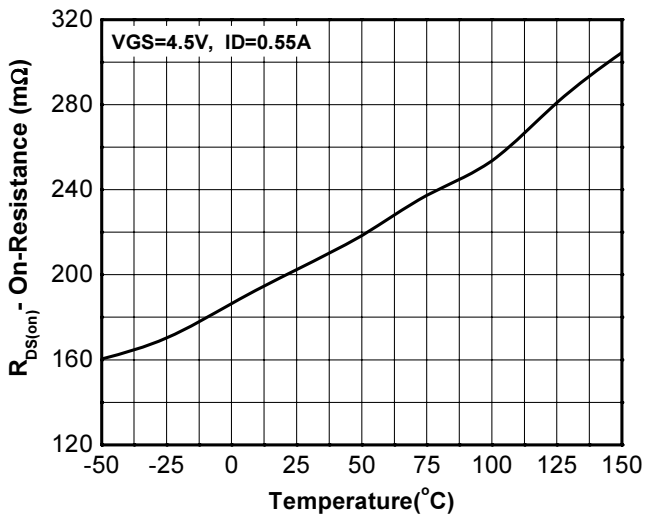
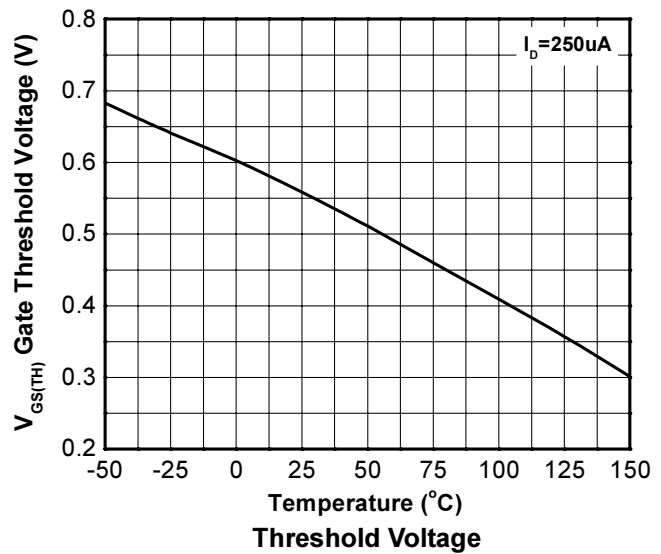
b Surface mounted on FR4 board using minimum pad size, 1oz copper

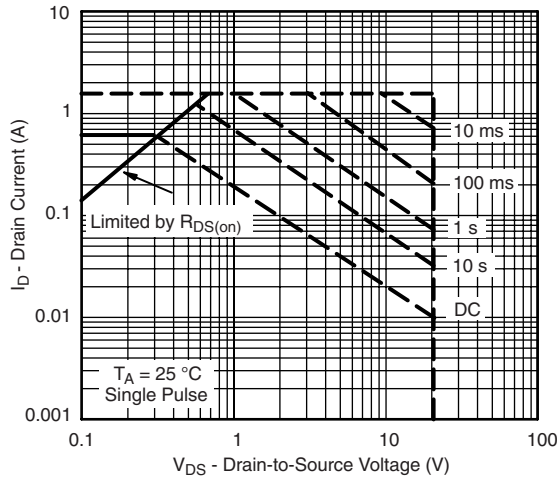
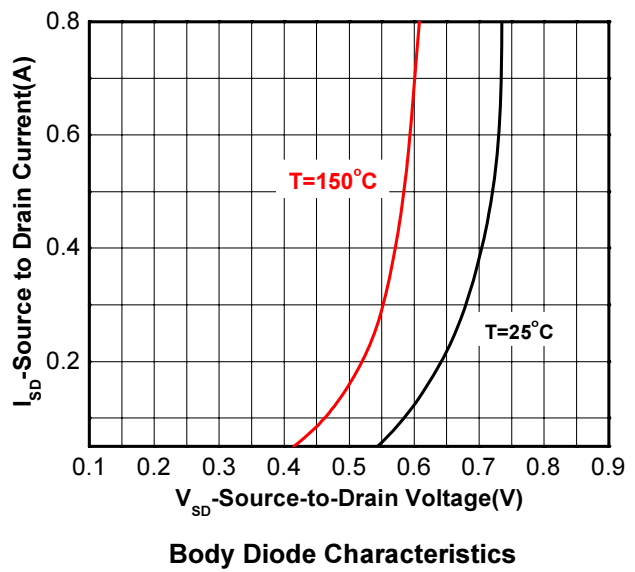
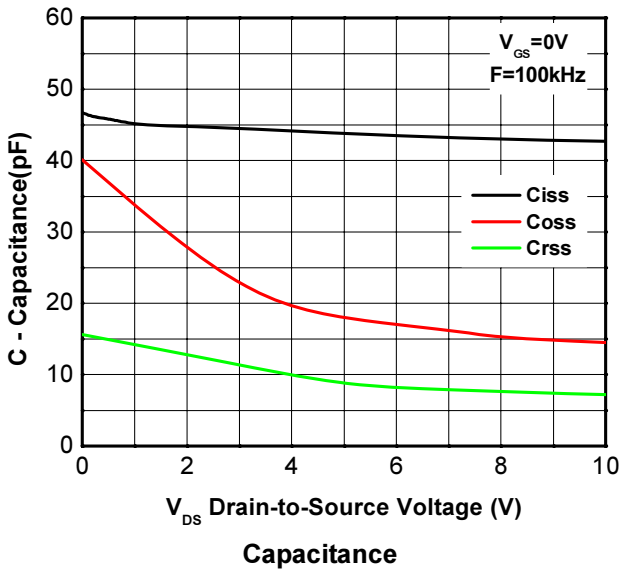
c Repetitive rating, pulse width limited by junction temperature, $t_p=10\mu\text{s}$, Duty Cycle=1%

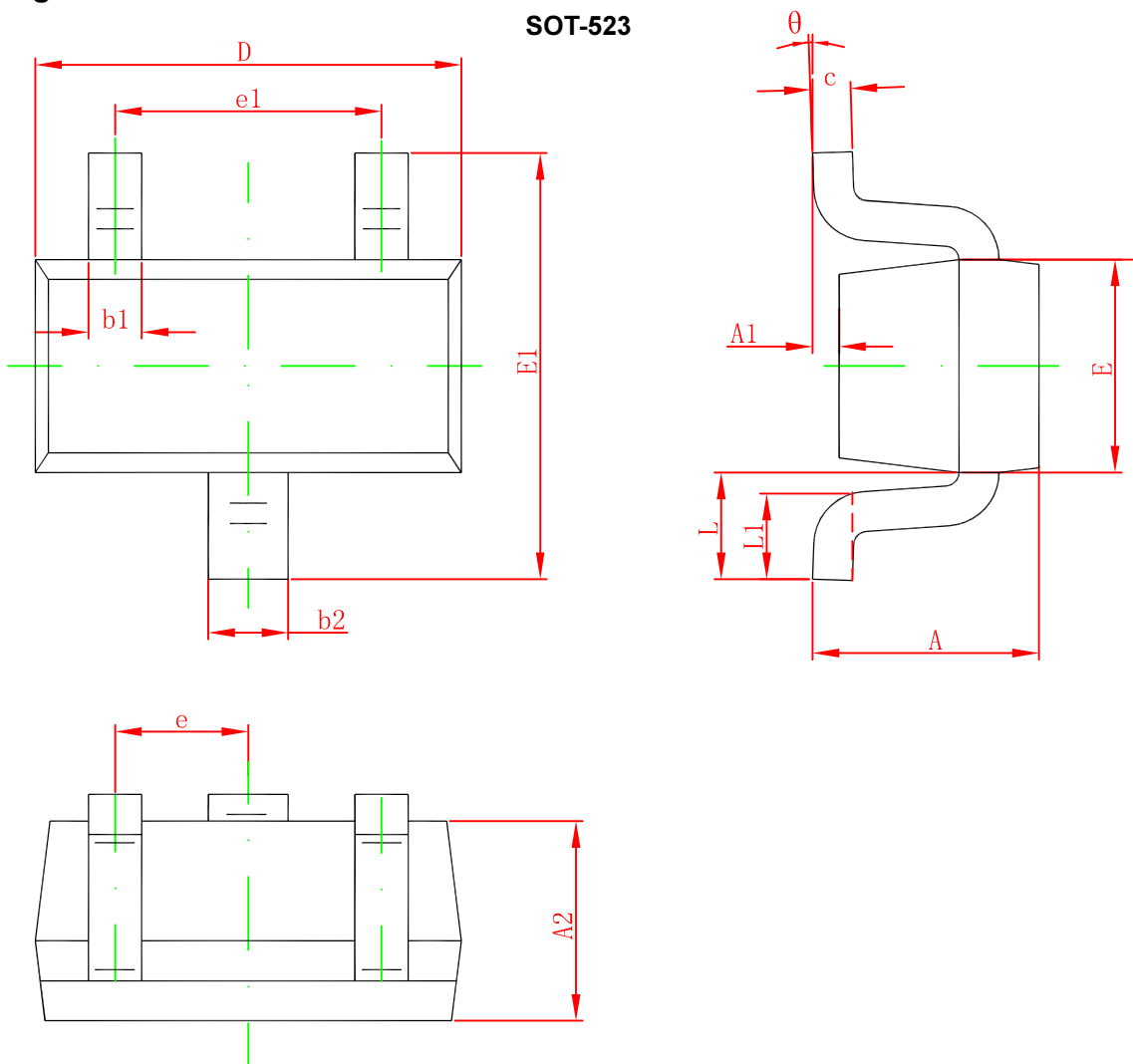
d Repetitive rating, pulse width limited by junction temperature $T_J=150^\circ\text{C}$.

Electronics Characteristics (T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ.	Max	Unit
Off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V, V _{GS} =0V			1	uA
I _{GSS}	Gate –Source leakage current	V _{DS} =0V, V _{GS} =±5V			±5	uA
ON Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250uA	0.45	0.55	1.0	V
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =4.5V, I _D =0.55A		220	310	mΩ
		V _{GS} =2.5V, I _D =0.45A		260	360	mΩ
		V _{GS} =1.8V, I _D =0.35A		320	460	mΩ
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D =0.4A		1.0		S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=100kHz		68		pF
C _{oss}	Output Capacitance			9.0		pF
C _{rss}	Reverse Transfer Capacitance			7.5		pF
Q _{G(TOT)}	Total Gate Charge	V _{DS} =10V, V _{GS} =4.5V, I _D =0.55A		1.15		nC
Q _{G(TH)}	Threshold gate charge			0.06		nC
Q _{GS}	Gate-Source Charge			0.15		nC
Q _{GD}	Gate-Drain Charge			0.23		nC
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} =10V, V _{GS} =4.5V, I _D =0.55A, R _G =6Ω		22		ns
t _r	Turn-On Rise Time			80		ns
t _{d(off)}	Turn-Off Delay Time			700		ns
t _f	Turn-Off Fall Time			380		ns
Body Diode Characteristics						
V _{SD}	Forward Diode Voltage	V _{GS} =0V, I _S =0.35A	0.5	0.7	1.5	V

Typical Performance Graph

Output Characteristics

Transfer Characteristics

On Resistance vs. Drain Current

On Resistance vs. V_{GS} vs. Temperature

On Resistance vs. Junction Temperature

Threshold Voltage



Package Outline Dimensions
SOT-523


Symbol	Dimension in Millimeters	
	Min.	Max.
A	0.700	0.900
A1	0.000	0.100
A2	0.700	0.800
b1	0.150	0.250
b2	0.250	0.350
c	0.100	0.200
D	1.500	1.700
E	0.700	0.900
E1	1.450	1.750
e	0.500 Typ.	
e1	0.900	1.100
L	0.400 Ref.	
L1	0.260	0.460
θ	0°	8°

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [MOSFET](#) category:

Click to view products by [Will Semiconductor](#) manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [FDPF9N50NZ](#) [FW216A-TL-2W](#) [FW231A-TL-E](#) [APT5010JVR](#) [NTNS3A92PZT5G](#)
[IRF100S201](#) [JANTX2N5237](#) [2SK2464-TL-E](#) [2SK3818-DL-E](#) [FCA20N60_F109](#) [FDZ595PZ](#) [STD6600NT4G](#) [FSS804-TL-E](#) [2SJ277-DL-E](#)
[2SK1691-DL-E](#) [2SK2545\(Q,T\)](#) [D2294UK](#) [405094E](#) [423220D](#) [MCH6646-TL-E](#) [TPCC8103,L1Q\(CM](#) [367-8430-0972-503](#) [VN1206L](#)
[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)
[IPS70R2K0CEAKMA1](#) [RJK60S3DPP-E0#T2](#) [RJK60S5DPK-M0#T0](#) [APT5010JVFR](#) [APT12031JFLL](#) [APT12040JVR](#) [DMN3404LQ-7](#)
[NTE6400](#) [JANTX2N6796U](#) [JANTX2N6784U](#) [JANTXV2N5416U4](#) [SQM110N05-06L-GE3](#) [SIHF35N60E-GE3](#)